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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/735,692	12/16/2003	Tetsushi Kawamura	246598US3	3554
22850	7590 10/05/2005		EXAMINER	
OBLON, SPIVAK, MCCLELLAND, MAIER & NEUSTADT, P.C. 1940 DUKE STREET			ELLINGTON, ALANDRA	
ALEXANDRIA, VA 22314			ART UNIT	PAPER NUMBER
			2855	

DATE MAILED: 10/05/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	10/735,692	KAWAMURA ET AL			
Office Action Summary	Examiner	Art Unit			
	Alandra Ellington	2855			
The MAILING DATE of this communic Period for Reply	cation appears on the cover sheet wi	th the correspondence address			
A SHORTENED STATUTORY PERIOD FOWHICHEVER IS LONGER, FROM THE MADE of the provisions of time may be available under the provisions of after SIX (6) MONTHS from the mailing date of this community. If NO period for reply is specified above, the maximum states a Failure to reply within the set or extended period for reply within the	AILING DATE OF THIS COMMUNION of 37 CFR 1.136(a). In no event, however, may a removed in the control of the con	CATION. eply be timely filed THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).			
Status					
1)⊠ Responsive to communication(s) filed	d on <i>amendment filed on 7/22/05</i> .				
2a) This action is FINAL . 2	· · · · · · · · · · · · · · · · · · ·				
3) Since this application is in condition f	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is				
closed in accordance with the practic	e under <i>Ex parte Quayle</i> , 1935 C.D	. 11, 453 O.G. 213.			
Disposition of Claims					
4) ☐ Claim(s) 1-7 is/are pending in the approach 4a) Of the above claim(s) is/are 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-7 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restrict	e withdrawn from consideration.				
Application Papers					
9) ☐ The specification is objected to by the 10) ☑ The drawing(s) filed on 16 December Applicant may not request that any object Replacement drawing sheet(s) including 11) ☐ The oath or declaration is objected to	2003 is/are: a)⊠ accepted or b)☐ tion to the drawing(s) be held in abeyan the correction is required if the drawing	nce. See 37 CFR 1.85(a). (s) is objected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119					
12) △ Acknowledgment is made of a claim f a) △ All b) □ Some * c) □ None of: 1. △ Certified copies of the priority of	documents have been received. documents have been received in A of the priority documents have been nal Bureau (PCT Rule 17.2(a)).	pplication No received in this National Stage			
Attachment(s) 1) Notice of References Cited (PTO-892)	A) Therview S	Summary (PTO-413)			
2) Notice of Praftsperson's Patent Drawing Review (PT 3) Information Disclosure Statement(s) (PTO-1449 or F Paper No(s)/Mail Date	rO-948) Paper No(s	s)/Mail Date nformal Patent Application (PTO-152)			

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Non-Final Rejection

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1, 2 and 5-7 are rejected under 35 U.S.C. 102(b) as being anticipated by Baba et al (6,085,598) (hereinafter Baba).
 - a. With respect to claim 1, Baba discloses a pressure sensor including a semiconductor device 15 capable of detecting pressure; a bonding wire 17; a terminal 10 that is connected to the semiconductor device 15 by the bonding wire 17; a housing 6 having an accommodation space accommodating the semiconductor device 15, the bonding wire 17 and the terminal 10; a diaphragm 12 sealing the accommodation space; and a working fluid 18 that is sealed in the accommodation space and transmits pressure applied to the diaphragm 12 to the semiconductor device 15, wherein the working fluid 18 is a silicone-based oil; and the terminal 10 and the housing 6 are sealed by a fluorine-based adhesive 16 (col. 4 lines 28-48 {Figs. 2 and 3B}).
 - b. With respect to claim 2, Baba discloses a pressure sensor including a semiconductor device 15 capable of detecting pressure; a bonding wire 17; a terminal 10 that is connected to the semiconductor device 15 by the bonding wire 17; and a housing 6 having an accommodation space accommodating the

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semiconductor device 15, the bonding wire 17 and the terminal 10, wherein the terminal 10 and the housing 6 are sealed by a fluorine-based adhesive 16 (col. 4 lines 28-48 {Figs. 2 and 3B}).

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- c. With respect to claim 5, Baba discloses the pressure sensor according to claim 2, wherein the pressure sensor does not include a working fluid ({Fig. 16}).
- d. With respect to claim 6, Baba discloses a method of making a pressure sensor including a semiconductor capable of detecting pressure; a bonding wire; a terminal that is connected to the semiconductor device by the bonding wire; a housing having an accommodation space accommodating the semiconductor device, the bonding wire and the terminal; a diaphragm sealing the accommodation space; and a working fluid that is sealed in the accommodation space and transmits pressure applied to the diaphragm to the semiconductor device, where the working fluid is a silicone-based oil; and the terminal and the housing are sealed by a fluorine-based adhesive, the method comprising sealing the terminal 10 and the housing 6 with the fluorine-base adhesive 16; and producing the pressure sensor of claim 1 (col. 4 lines 28-48 {Figs. 2 and 3B}).
- e. With respect to claim 7, Baba discloses a method of making a pressure sensor including a semiconductor device capable of detecting pressure; a bonding wire; a terminal that is connected to the semiconductor device by the bonding wire; and a housing having an accommodation space accommodating the semiconductor device, the bonding wire and the terminal, where the terminal and the housing are sealed by a fluorine-based adhesive, the method comprising

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sealing the terminal 10 and the housing 6 with the fluorine-based adhesive 16; and producing the pressure sensor of claim 2 (col. 4 lines 28-48 {Figs. 2 and 3B}).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 3 and 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Baba.
 - a. With respect to claims 3 and 4, Baba discloses the claimed invention except for specifically teaching a perfluoro polyether resin composition.

 However, Baba teaches a fluorine-based adhesive16 surrounding the semiconductor device 15 and terminal 10 (col. 4 lines 34-44 {Fig. 3B}). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify Baba to include a specific type of fluorine based adhesive for the purpose of protecting the electronic devices during operation.

Response to Arguments

5. Applicant's arguments with respect to claims 1-7 have been considered but are moot in view of the new ground(s) of rejection.

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Conclusion

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Alandra Ellington whose telephone number is (571) 272-2178. The examiner can normally be reached on Monday - Friday, 8:30am - 5:00pm.

- 7. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Edward Lefkowitz can be reached on (571) 272-2180. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.
- 8. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Alandra Ellington Art Unit 2855

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MAX NOOR! PRIMARY EXAMINER